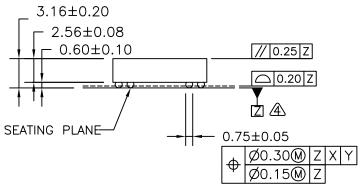


BOTTOM VIEW



SIDE VIEW

NOTES:

- ALL DIMENSIONS ARE IN MILLIMETERS UNLESS OTHERWISE SPECIFIED.
- 2. MATERIAL MUST COMPLY WITH BANNED AND RESTRICTED SUBSTANCES SPEC # 10-0131.
- 3. THE BASIC SOLDER BALL GRID PITCH IS 1.27 MM.
- PRIMARY DATUM Z AND SEATING PLANES ARE DEFINED BY THE SPHERICAL CROWNS OF THE SOLDER BALLS.
- A1 CORNER MUST BE IDENTIFIED BY LASER MARK ON TOP PACKAGE.
- 6. ALL DIMENSIONS APPLY TO LEADED (-), LEAD FREE (+) PKG. CODES.
- 7. PACKAGE CDDE: V36-1

TITLE:

PACKAGE OUTLINE, 36 BALLS PBGA, W/ CRYSTAL 11.43.x10.16x3.16mm, 1.27mm PITCH, 2 LAYER

APPROVAL EDEN CHEN 09/06/10 DOCUMENT CONTROL NO.

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REV.